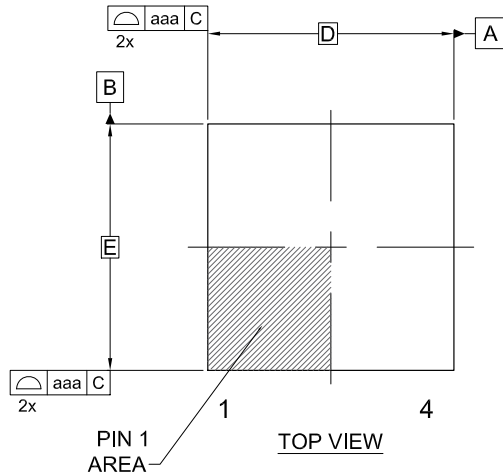
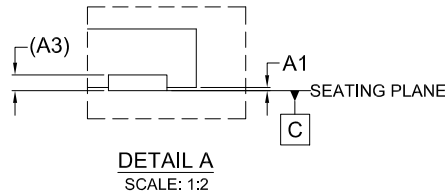


TDFN4 8.00x8.00x1.00, 2.00P
CASE 520AB
ISSUE A

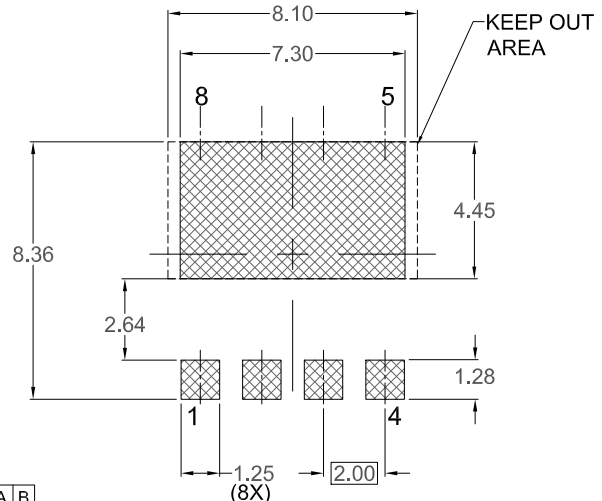
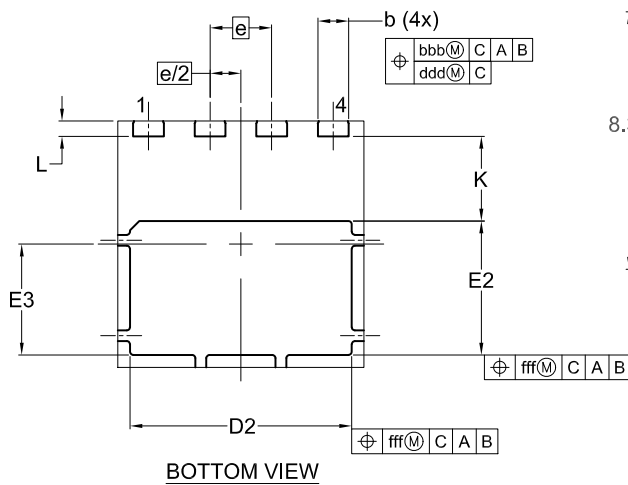
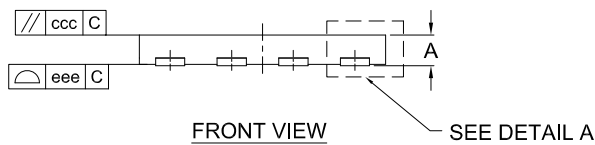
DATE 07 JUN 2024



- NOTES:
 A) DIMENSIONS AND TOLERANCING CONFIRM TO ASME Y14.5-2018.
 B) ALL DIMENSIONS ARE IN MILLIMETERS.
 C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
 D) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.



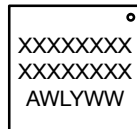
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
A1	0.00	---	0.05
A3	0.20 REF		
b	0.90	1.00	1.10
D	8.00 BSC		
D2	7.10	7.20	7.30
E	8.00 BSC		
E2	4.25	4.35	4.45
E3	3.50	3.60	3.70
e	2.00 BSC		
e/2	1.00 BSC		
K	2.65	--	--
L	0.40	0.50	0.60
aaa	0.10		
bbb	0.10		
ccc	0.05		
ddd	0.05		
eee	0.10		
fff	0.10		



RECOMMENDED LAND PATTERN

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



- XXXX = Specific Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	TDFN4 8.00x8.00x1.00, 2.00P	PAGE 1 OF 1

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